

MAXIMUM RATINGS

Rating	Symbol	2N3498	2N3500	Unit
		2N3499	2N3501	
Collector-Emitter Voltage	V _{CEO}	100	150	V _{dc}
Collector-Base Voltage	V _{CBO}	100	150	V _{dc}
Emitter-Base Voltage	V _{EBO}	6.0		V _{dc}
Collector Current — Continuous	I _C	500	300	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	1.0		Watt mW/°C
		5.71		
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	5.0		Watts mW/°C
		28.6		
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{θJC}	35	°C/W
Thermal Resistance, Junction to Ambient	R _{θJA}	175	°C/W

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage (1) (I _C = 10 mAdc, I _B = 0)	2N3498, 2N3499 2N3500, 2N3501	V _{(BR)CEO}	100 150	— —	— —	V _{dc}
Collector-Base Breakdown Voltage (I _C = 10 μAdc, I _E = 0)	2N3498, 2N3499 2N3500, 2N3501	V _{(BR)CBO}	100 150	— —	— —	V _{dc}
Emitter-Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0)		V _{(BR)EBO}	6.0	— —	— —	V _{dc}
Collector Cutoff Current (V _{CB} = 50 Vdc, I _E = 0) (V _{CB} = 50 Vdc, I _E = 0, T _A = 150°C) (V _{CB} = 75 Vdc, I _E = 0) (V _{CB} = 75 Vdc, I _E = 0, T _A = 150°C)	2N3498, 2N3499 2N3500, 2N3501	I _{CBO}	— — — —	— — — —	0.050 50 0.050 50	μAdc
Emitter Cutoff Current (V _{BE(off)} = 4.0 Vdc, I _C = 0)		I _{EBO}	—	—	25	nAdc

ON CHARACTERISTICS

DC Current Gain (I _C = 0.1 mAdc, V _{CE} = 10 Vdc)	2N3498, 2N3500 2N3499, 2N3501	h _{FE}	20 35	— —	— —	—
(I _C = 1.0 mAdc, V _{CE} = 10 Vdc)	2N3498, 2N3500 2N3499, 2N3501		25 50	— —	— —	—
(I _C = 10 mAdc, V _{CE} = 10 Vdc)	2N3498, 2N3500 2N3499, 2N3501		35 75	— —	— —	—
(I _C = 150 mAdc, V _{CE} = 10 Vdc)	2N3498, 2N3500 2N3499, 2N3501		40 100	— —	120 300	—
(I _C = 300 mAdc, V _{CE} = 10 Vdc)	2N3500 2N3501		15 20	— —	— —	—
(I _C = 500 mAdc, V _{CE} = 10 Vdc)	2N3498 2N3499		15 20	— —	— —	—
Collector-Emitter Saturation Voltage (I _C = 10 mAdc, I _B = 1.0 mAdc) (I _C = 50 mAdc, I _B = 5.0 mAdc) (I _C = 150 mAdc, I _B = 15 mAdc) (I _C = 300 mAdc, I _B = 30 mAdc)	All Types All Types 2N3500, 2N3501 2N3498, 2N3499		V _{CE(sat)}	— — — —	— — — —	0.2 0.25 0.4 0.6

2N3498 thru 2N3501

JAN, JTX, JTXV AVAILABLE
CASE 79-02, STYLE 1
TO-39 (TO-205AD)

GENERAL PURPOSE TRANSISTOR

NPN SILICON

2N3498 thru 2N3501

ELECTRICAL CHARACTERISTICS (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Base-Emitter Saturation Voltage ($I_C = 10\text{ mAdc}, I_B = 1.0\text{ mAdc}$) ($I_C = 50\text{ mAdc}, I_B = 5.0\text{ mAdc}$) ($I_C = 150\text{ mAdc}, I_B = 15\text{ mAdc}$) ($I_C = 300\text{ mAdc}, I_B = 30\text{ mAdc}$)	$V_{BE(sat)}$	—	—	0.8 0.9 1.2 1.4	Vdc

SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product(2) ($V_{CE} = 20\text{ Vdc}, I_C = 20\text{ mAdc}, f = 100\text{ MHz}$)	f_T	150	—	—	MHz
Output Capacitance ($V_{CB} = 10\text{ Vdc}, I_E = 0, f = 100\text{ kHz}$)	C_{obo}	—	—	10 8.0	pF
Input Capacitance ($V_{BE} = 0.5\text{ Vdc}, I_C = 0, f = 100\text{ kHz}$)	C_{ibo}	—	—	80	pF
Input Impedance ($I_C = 10\text{ mAdc}, V_{CE} = 10\text{ Vdc}, f = 1.0\text{ kHz}$)	h_{ie}	0.2 0.25	—	1.0 1.25	k ohms
Voltage Feedback Ratio ($I_C = 10\text{ mAdc}, V_{CE} = 10\text{ Vdc}, f = 1.0\text{ kHz}$)	h_{re}	—	—	2.5 4.0	$\times 10^{-4}$
Small-Signal Current Gain ($I_C = 10\text{ mAdc}, V_{CE} = 10\text{ Vdc}, f = 1.0\text{ kHz}$)	h_{fe}	50 75	—	300 375	—
Output Admittance ($I_C = 10\text{ mAdc}, V_{CE} = 10\text{ Vdc}, f = 1.0\text{ kHz}$)	h_{oe}	—	—	100 200	μmhos

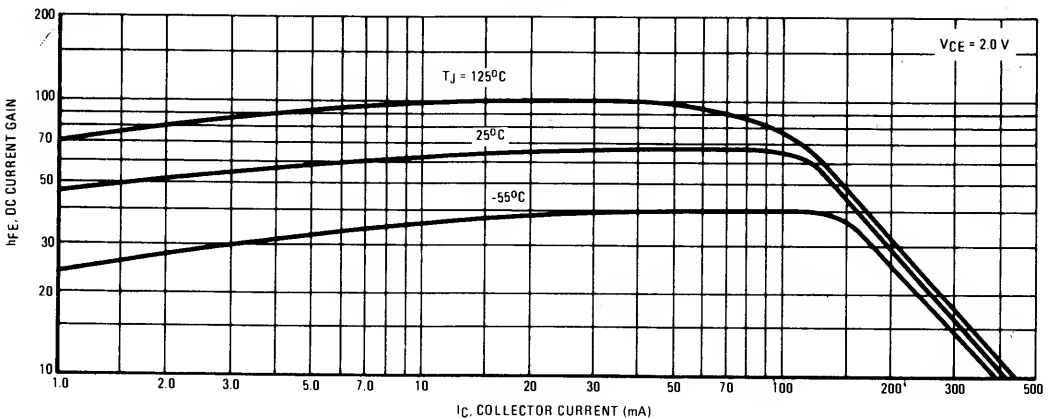
SWITCHING CHARACTERISTICS

Delay Time ($I_C = 150\text{ mAdc}, I_{B1} = 15\text{ mAdc}, V_{CC} = 100\text{ Vdc}, V_{BE(off)} = 2.0\text{ Vdc}$)	t_d	—	20	—	ns
Rise Time ($I_C = 150\text{ mAdc}, I_{B1} = 15\text{ mAdc}, V_{CC} = 100\text{ Vdc}, V_{BE(off)} = 2.0\text{ Vdc}$)	t_r	—	35	—	ns
Storage Time ($I_C = 150\text{ mAdc}, I_{B1} = I_{B2} = 15\text{ mAdc}, V_{CC} = 100\text{ Vdc}$)	t_s	—	800	—	ns
Fall Time ($I_C = 150\text{ mAdc}, I_{B1} = I_{B2} = 15\text{ mAdc}, V_{CC} = 100\text{ Vdc}$)	t_f	—	80	—	ns

(1) Pulse Test: Pulse Width $\leq 300\ \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

(2) $f_T = |h_{fe}| \cdot f_{test}$

**FIGURE 1 — CURRENT GAIN CHARACTERISTICS versus JUNCTION TEMPERATURE
2N3498**



2N3499

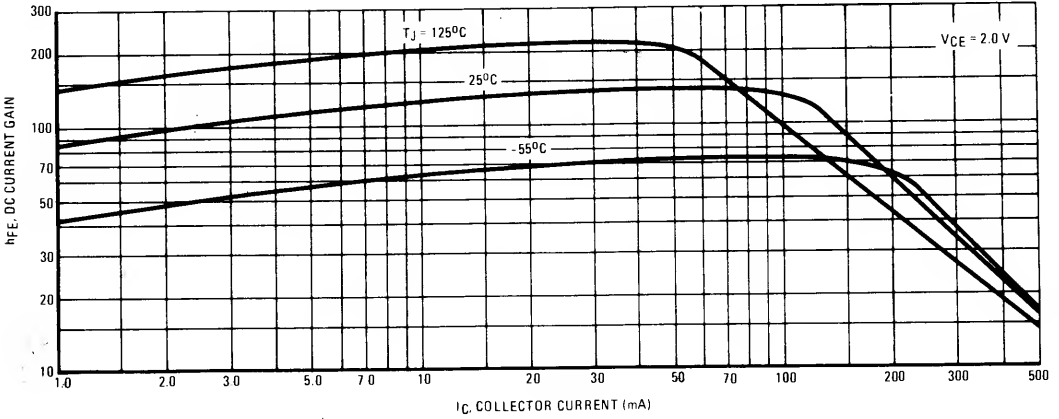


FIGURE 2 – CURRENT GAIN CHARACTERISTICS versus COLLECTOR-EMITTER VOLTAGE

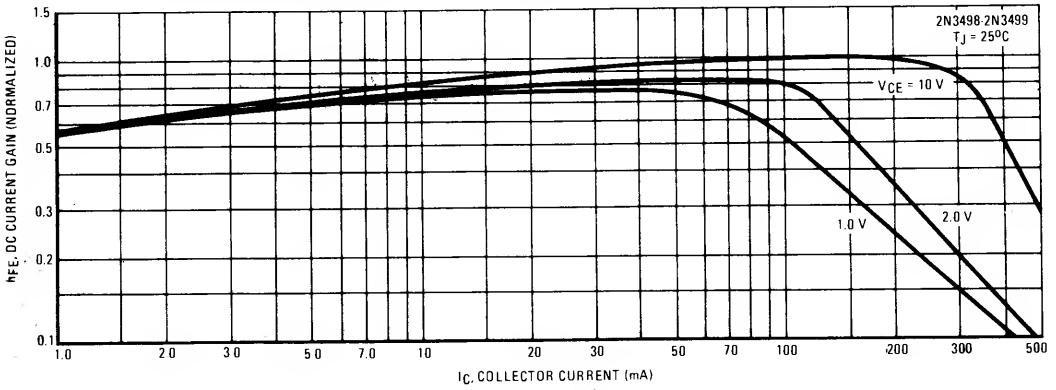
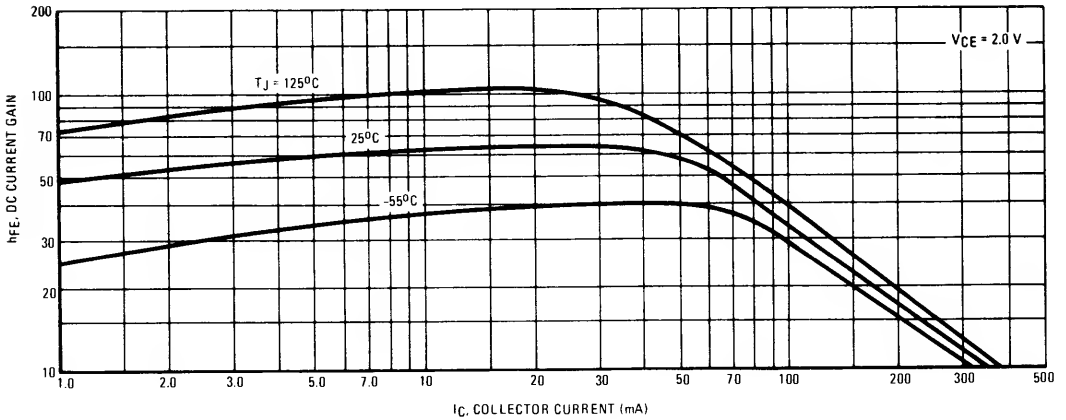


FIGURE 3 – CURRENT GAIN CHARACTERISTICS versus JUNCTION TEMPERATURE
2N3500



2N3498 thru 2N3501

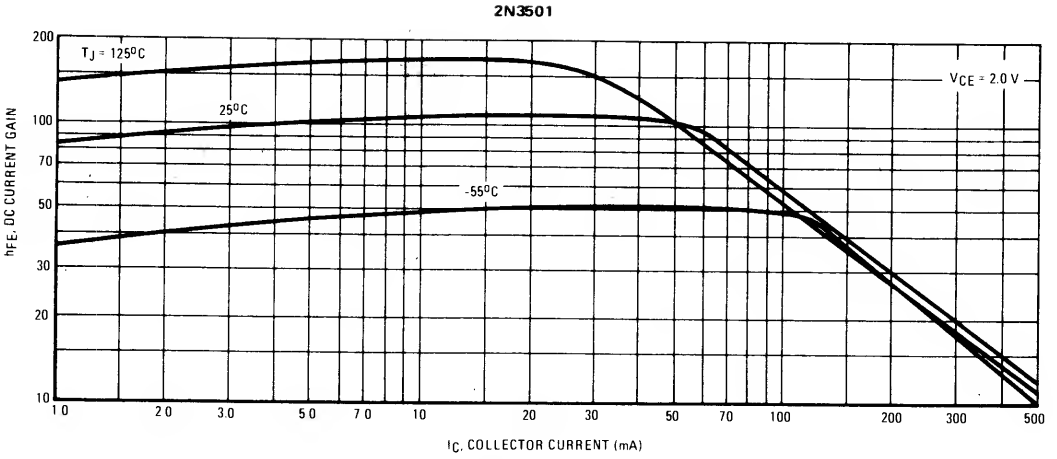


FIGURE 4 – CURRENT GAIN CHARACTERISTICS versus COLLECTOR-EMITTER VOLTAGE

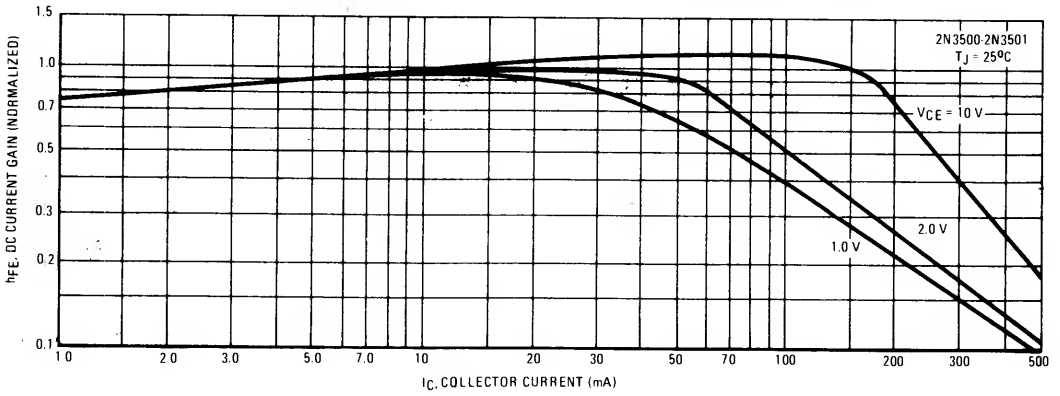


FIGURE 5 - "ON" VOLTAGES

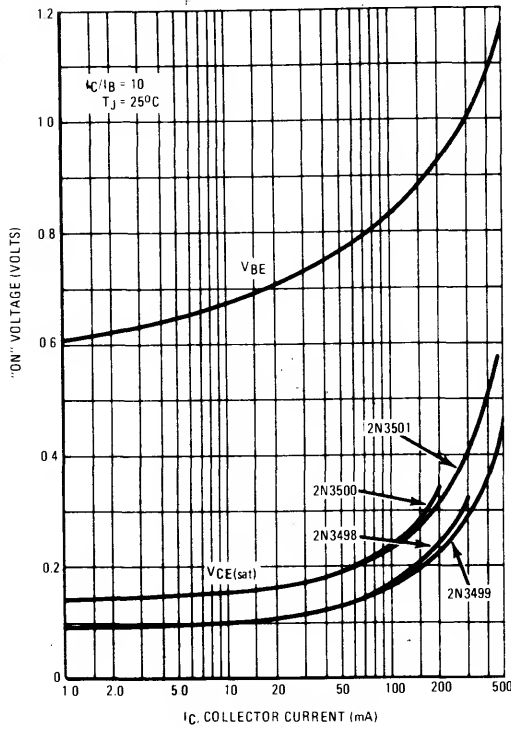


FIGURE 6 - TEMPERATURE COEFFICIENTS

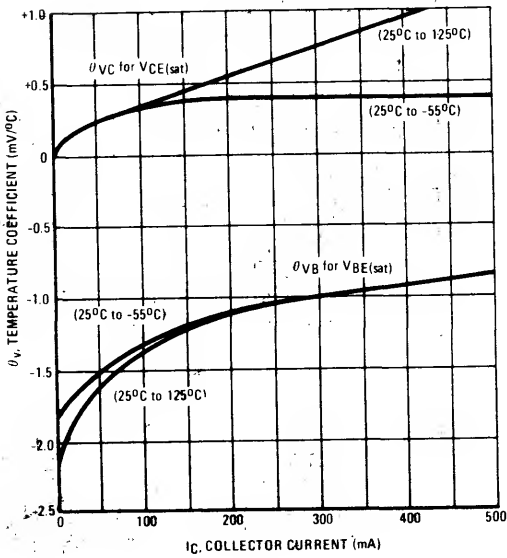
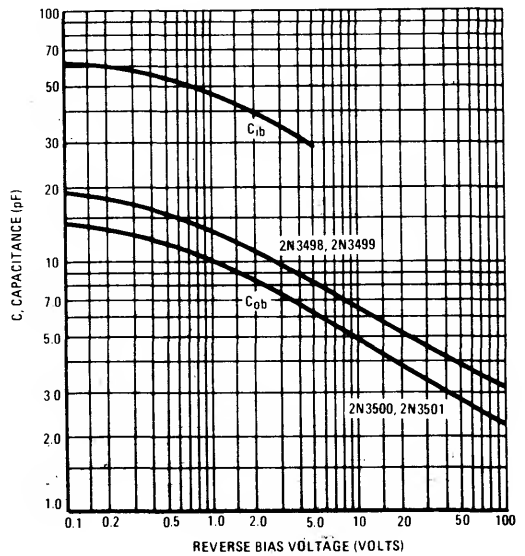


FIGURE 7 - CAPACITANCE



AUDIO SMALL-SIGNAL h PARAMETER CHARACTERISTICS

($V_{CE} = 10 \text{ Vdc}$, $T_A = 25^\circ\text{C}$, $f = 1.0 \text{ kHz}$)

FIGURE 8 – CURRENT GAIN

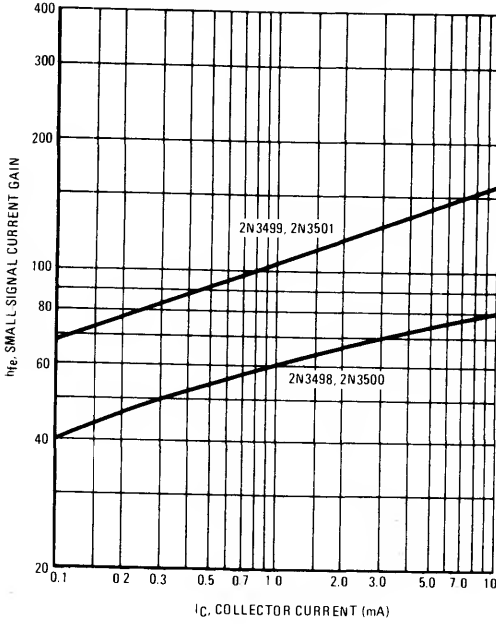


FIGURE 9 – OUTPUT IMPEDANCE

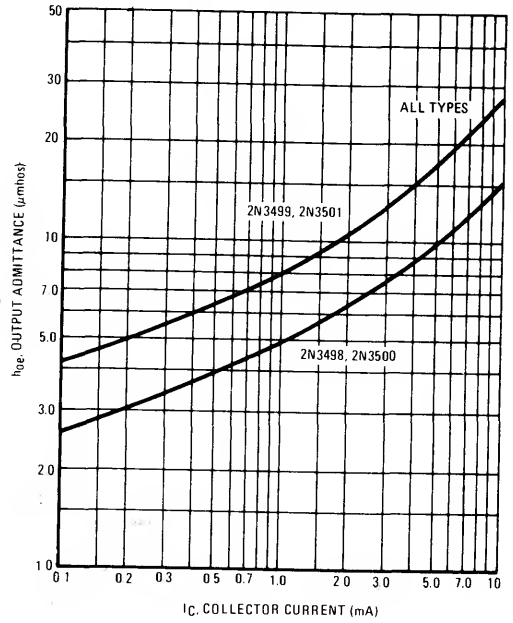


FIGURE 10 – INPUT IMPEDANCE

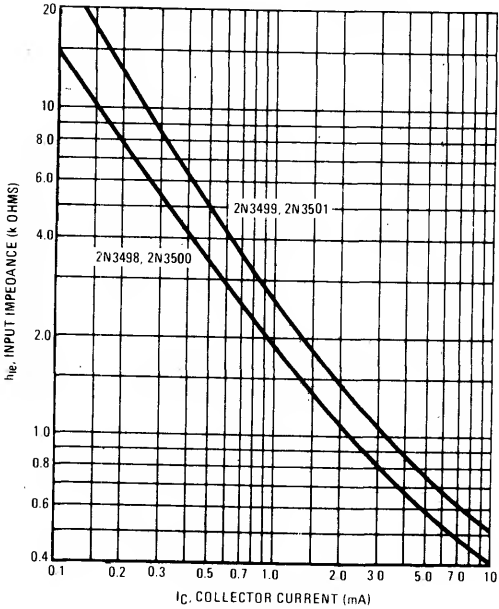


FIGURE 11 – VOLTAGE FEEDBACK RATIO

